

EL465779215



Inventor: Chris Parf niuk et al.

Title: M thods of Bonding First and Second Mass s to One

Another, and Methods of Bonding Physical Vapor

Deposition Target Materials To Backing Plate Materials

Assignee: Honeywell International, Inc.

Serial No.: 09/488,973

Filed: CPA Filed Herewith

Client Ref.: 30-5016-(4015)

TC 2800 MAIL ROOM
NOV 28 2001

RECEIVED

INFORMATION DISCLOSURE STATEMENT
PURSUANT TO 37 C.F.R. §§ 1.56, 1.97 AND 1.98

In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, the Examiner's attention is directed to the references listed on the attached Form PTO-1449 and copies of which are attached. No admission is made regarding whether all the submitted references are prior art.

Citation of these references is respectfully requested.

Respectfully submitted,

Date: 11/13/01 Attorney: Davis

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